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7542Group

Input Capture

1. Abstract

The following article introduces and shows an application example of input capture.

2. Introduction

The explanation of this issue is applied to the following condition: Applicable MCU: 7542 Group



3. Input Capture Setting Method

Figure 1, Figure 2 and Figure 3 shows the setting method for input capture 0.

Also, when input capture 1 is used, the procedure is the same.

Process 1: Disable timer A interrupt and capture 0 interrupt. ^{b7} Interrupt control register 2 (ICON2) [Address: 3F16] Capture 0 interrupt disabled Timer A interrupt disabled							
Process 2: Stop timer A counting.							
Timer A, B mode register (TABM) [Address: 1D16]							
Process 3: Set timer count source set register.							
b7 b0 Timer count source set register (TCSS) [Address: 2A16] Timer A count source selection bits b4b3b2 0 0 0 : f(XIN)/16 0 0 1 : f(XIN)/2 0 1 0 : f(XIN)/32 0 1 1 : f(XIN)/64 1 0 0 : f(XIN)/128 1 0 1 : f(XIN)/256 1 1 0 : On-chip oscillator output 1 1 1 : Not available							
Process 4: Set the count value to timer A.							
Timer A register (low-order) (TAL) [Address: 2416] Count value Timer A register (high-order) (TAH) [Address: 2516] Count value							
Note: When setting the value to timer, set in order of low-order byte and high-order byte following.							
Process 5: Select timer source for capture.							
b7 b0 Timer source selection register (TMSR) [Address: 1F16] Capture 0 timer source: Timer A							

Figure 1 Setting method for input capture (1)



Process 6: Set capture mode register.
^{b7} b0 Capture mode register (CAPM) [Address: 2016]
Capture 0 interrupt edge selection bits
b1b0 0 0 : Rising and falling edge
0 1 : Rising edge 1 0 : Falling edge
1 1 : Not available
Capture 0 noise filter clock selection bits b5b4
0 0 : Filter stop
0 1 : f(XIN) 1 0 : f(XIN)/8
1 1 : f(XIN)/32
Process 7: Set capture 0 input port selection bits.
b7 b0 Capture/compare port register (CCPR) [Address: 1E16]
Capture 0 input port selection bits
b1b0 0 0 : Capture from P00
0 1 : Capture from P10 1 0 : Ring/512
1 1 : Not available
Process 8: Set capture 0 input port to input mode.
^{b7} b0 Port Px direction register (PxD) [Address: 0116, 0316]
P00/CAPo or P10/CAPo pin to input mode
Process 9: In order not to execute the unrequested interrupt processing, set "0" (no request) to the capture 0 interrupt request bit.
hterrupt request register 2 (IREQ2) [Address: 3D16]
No capture 0 interrupt request issued
Process 10: When using the capture interrupt, set "1" (interrupt enabled) to the capture 0 interrupt enable bit.
b7 b0 b7 Interrupt enable register 2 (ICON2) [Address: 3F16]
Capture 0 interrupt enabled
Process 11: Start counting timer A.
b7 b0 Timer A B mode register (TABM) [Address: 1D16]
Timer A, B mode register (TABM) [Address. 1010]

Figure 2 Setting method for input capture (2)



The capture input circuit retains the count value of selected timer to the capture latch when external trigger is input. The timer count value is retained to the capture latch x0 when rising edge of the external trigger is input and is retained to the capture latch x1 when falling edge of the external trigger is input.

The count value of timer can be retained by software by capture y (y = 00, 01, 10, 11) software trigger bit too.

When "1" is set to this bit, count value of timer is retained to the corresponded capture latch.

The latest status of capture latch can be confirmed by reading of the capture x status bit. This bit indicates the capture latch (x0 or x1) which latest data is in.

Capture 0 interrupt occurs when CAPo pin captures rising or falling edge. Read out the capture 0 value as follows after capture interrupt occurs;

<When rising edge is selected as the capture 0 interrupt edge>

Process a: Set "0" (capture latch 00 selected) to capture register R/W pointer .

b7		b0	~
	0		Cap
	· · · · ·		

apture/compare register R/W pointer (CCRP) [Address: 1216] - Capture latch 00

Process b: Read out capture 0 value from capture latch 00.

Capture register 0 (low-order) (CAPoL) [Address: 0C16]				
Capture 0 value				
Capture register 0 (high-order) (CAP0H) [Address: 0D16]				
Capture 0 value				
Capture 0 value Capture register 0 (high-order) (CAP0H) [Address: 0D16]				
Process c: Set "1" (capture latch 01 selected) to capture register R/W pointer .				
Capture latch 01				
Capture/compare register R/W pointer (CCRP) [Address: 1216] Capture latch 01 Process d: Read out capture 0 value from capture latch 01.				
Capture register 0 (low-order) (CAPoL) [Address: 0C16]				
Capture 0 value				
Capture register 0 (high-order) (CAPoH) [Address: 0D16]				
Capture 0 value				

Figure 3 Setting method for input capture (3)



4. Application Example of Input Capture

Outline

The waveform generated in the timer X pulse output mode is input to the input capture 0 input pin (P00/CAP0) and its pulse width is measured.

Specifications

The square waveform that clock f(XIN) = 1.8432 MHz is divided to 1.00 Hz is output from P14/CNTR0 pin.

The output waveform is input to P00/CAP0 pin and its "H" pulse width is measured by the input capture.

Reading out the capture latch register and the calculation of pulse width are performed in the capture 0 interrupt processing routine (falling edge trigger).

4.1 Peripheral circuit example

Figure 4 shows the peripheral circuit example.

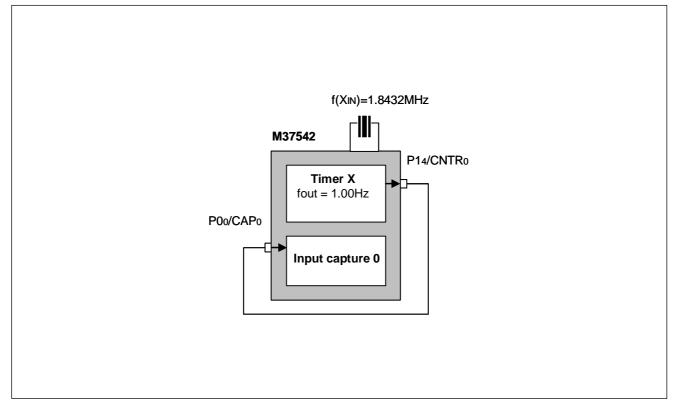


Figure 4 Peripheral circuit example

4.2 Example of control procedure

Figure 5 and Figure 6 shows the circuit example.



7542 Group Input Capture

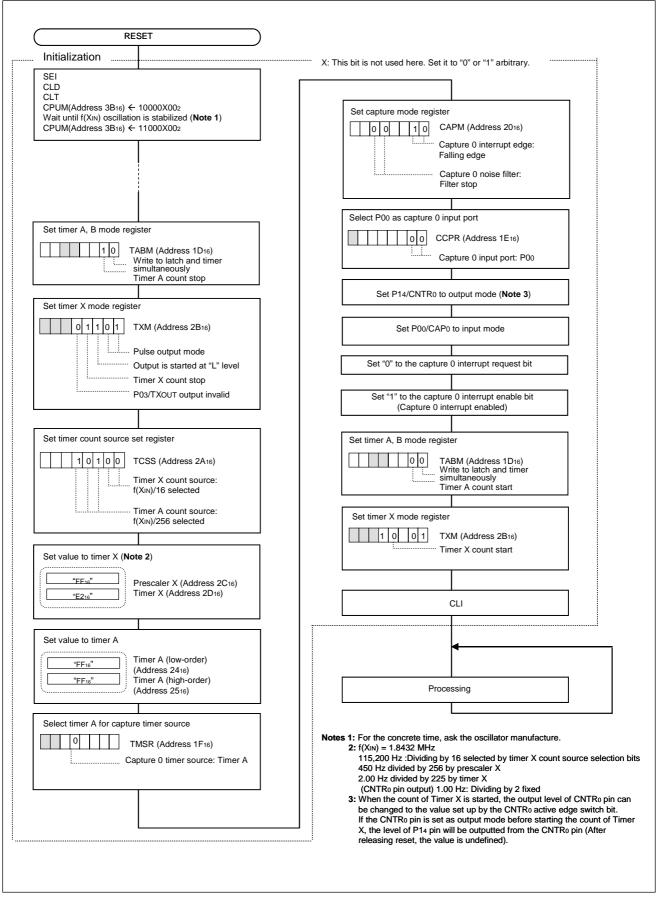


Figure 5 Example of control procedure (1)



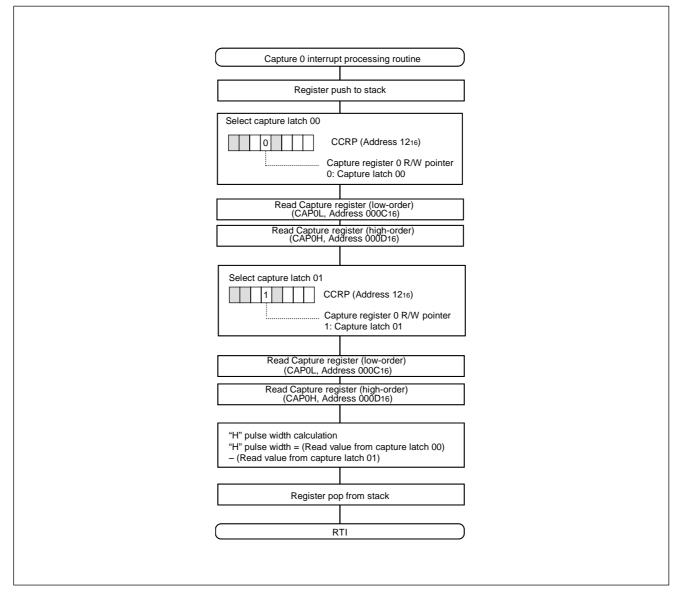


Figure 6 Example of control procedure (2)



5. Reference Document

Data Sheet 7542 Group Data sheet Download the latest version from the Renesas Technology website.

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Revision Record

		Description		
Rev.	Date	Page	Summary	
1.00	Jun.18.03	—	First edition issued	
2.00	Jul.01.04	All pages	Words standardized	
		6	Fig.5: Note 2 revised.	
3.00	Aug.29.06	3	Interrupt setting of timer A deleted.	



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